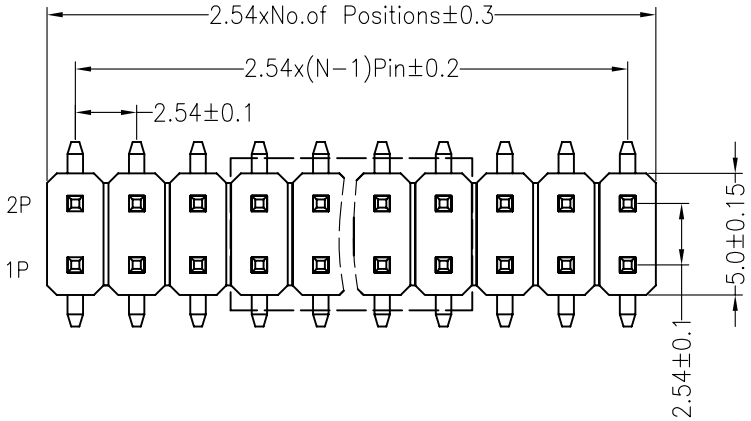
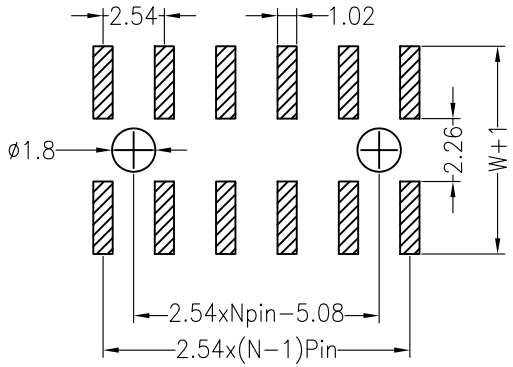
SPECIFICATIONS
Rated Current:3.0AMP
Contact Resistance:20mΩ Max
Withstand Voltage:1000V AC/DC
Insulation Resistance:1000MΩ Min
Operation Temperature:−40°c to +105°c

Contact Material:Brass
Contact Plating:Au or Sn Over Ni
Insulator Material:Polyester(UL94V−0)
Standard: PA6T
Max.Processing Temp: 230°C for 30−60 seconds
(260°C for 5 seconds)



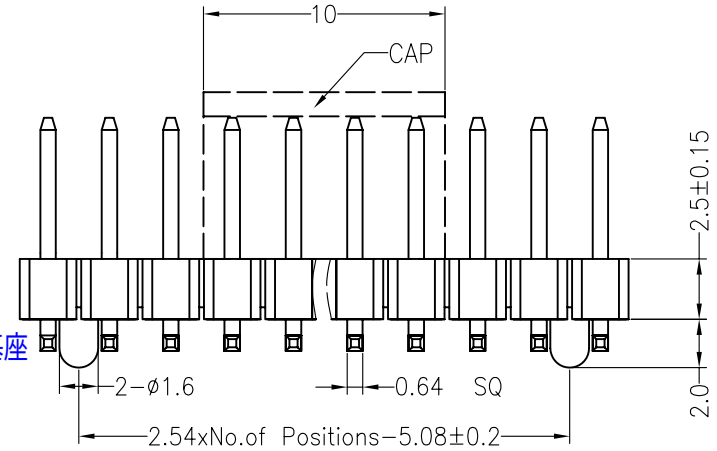
Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)

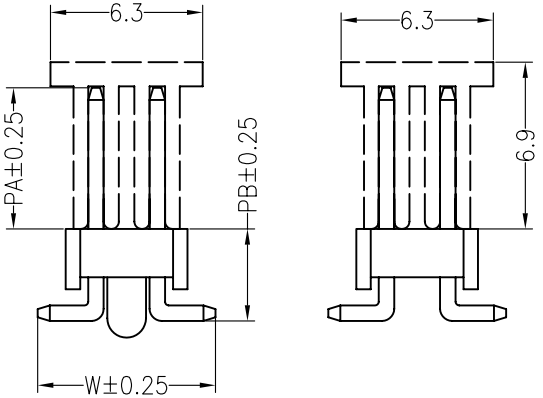


Ordering Information

1225 1 2 XX X X XX M XXX X 01-B 蓝色基座

No.of Pins Per Row 2*40	Insulator Material Option A=BK−PBT B=BK−PA66 C=BK−PA6T D=BK−PA46 F=BK−LCP	Post W=With Post N=W/O Post	Contact Plating G0:Gold Flash G2:5U" Gold G3:10U" Gold G4:15U" Gold G5:30U" Gold S0:Gold Flash/Tin SN:Tin	Pin Length	Packing 0=PE Bag A=Tray T=Tube P=Tube+Cap R=Reel+Cap M=Reel+Mylar	





Dimension antitheses list				
ITEM	PA	PB	W	L
Standard	6.00	3.20	7.50	11.0
Alternate				

REV	DATE	MODIFICATION DESCRIPTION	CHANGE
A0	2012.04.11	NEW DRAWING	

OPERATION	
X.X	±0.30
X.XX	±0.20
X.XXX	±0.10
Angle	±3°
DIM	TOL

DRAW	YiYuSheng	12.04.11
CHECK		
APPROVE		

SCALE	FIT
UNIT	mm
SIZE	A4
SHEET	1/1
PROJ.	

深圳市广德众电子科技有限公司

PART NO.	122512XXXXXXMXXXX01
TITLE:	2.54PH 2xNpin H2.5mm SMT